

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Chin-Teng Hsu	01/27/2010
RECEIVING PARTY DATA	
Name:	Lih Yeu Seng Industries Co., Ltd.
Street Address:	No. 160, Heping E. Rd.
City:	Yungkang City, Tainan County 710
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12720071
CORRESPONDENCE DATA	
Fax Number: (763)746-8125 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i> Phone: 763-746-1599 Email: ALAN@THELAWFIRM.CC Correspondent Name: KAMRATH & ASSOCIATES P.A. Address Line 1: 4825 OLSON MEMORIAL HIGHWAY Address Line 2: SUITE 245 Address Line 4: GOLDEN VALLEY, MINNESOTA 55422	
ATTORNEY DOCKET NUMBER:	NL175-32
NAME OF SUBMITTER:	Alan D. Kamrath
Total Attachments: 1 source=20100309134750#page1.tif	

OP \$40.00 12720071

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REEL: 024051 FRAME: 0390

ASSIGNMENT

WHEREAS, I/We

(1) HSU, CHIN-TENG of Taiwan (R.O.C.)

(2) _____ of _____

hereafter referred to as applicant, have invented certain new and useful improvements in
SHOCK- AND MOISTURE-RESISTANT CONNECTOR ASSEMBLY

for which an application for a United States Patent was executed on January 27, 2010, and

WHEREAS, LIH YEU SENG INDUSTRIES. CO., LTD. of Taiwan (R.O.C.)
herein referred to as "Assignee" whose mailing address is _____
No.160, Heping E. Rd., Yungkang City, Tainan Country 710, Taiwan (R.O.C.)

is desirous of acquiring the entire right, title and interest in and to said invention, and in and to and
under any and all Letters Patent to be obtained thereon;

NOW, THEREFORE, for and in consideration of one Dollar (\$1.00) and other good and
valuable considerations, the receipt of which is hereby acknowledged, I/We the applicant(s) have sold,
assigned and transferred, and by these presents do hereby sell, assign and transfer unto the Assignee,
its successors and assigns the entire right, title and interest in and to said invention, said application
and the Letters Patent, both foreign and domestic, that may or shall issue, including all of my rights
under the International Convention, and I do hereby authorize and request the Commissioner of
Patents and Trademarks to issue said Letters Patent to the Assignee in accordance herewith.

Upon said consideration, I/We do hereby covenant and agree with the said Assignee, its
successors and assigns, that I/We will not execute any writing or do any act whatsoever conflicting
with these presents, and that I/We or my/our executors or administrators will at any time upon request,
without further or additional consideration, but at the expense of the said Assignee, its successors and
assigns, execute such additional writings and do such additional acts as said Assignee, its successors
and assigns, may deem necessary or desirable to perfect the Assignee's enjoyment of this grant, and
render all necessary assistance in making application for and obtaining original, divisional,
continuation, reissued or extended Letters Patent of the United States, or of any and all foreign
countries on said invention, and in enforcing any rights, occurring as a result of such applications or
patents, by giving testimony in any proceedings or transactions involving such applications or patents.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned
(name).

(1) Date 1.27.2010. Name of Inventor Hsu Chin Teng.

(2) Date _____ Name of Inventor _____

Note: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are
required. Submit multiple forms if more than two signatures are required.

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